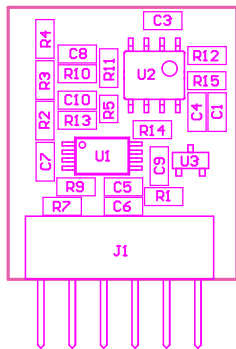


ZZ1 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: [No Variations]

|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE         | BOARD #: TIDA-01141              | REV: E1           | SUN REV: Not In VersionControl |
| M5 Assembly Top                  | TID #: TIDA-01141                |                   |                                |
| PLOT NAME = Top Assembly Drawing | GENERATED : 12/8/2016 3:12:25 PM | TEXAS INSTRUMENTS |                                |

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